



PR/161123 | Senior Field Application Engineer (CCL / PCB)

Job Information

Recruiter

JAC Recruitment Malaysia

Job ID

1614539

Industry

Electronics, Semiconductor

Job Type

Permanent Full-time

Location

Malaysia

Salary

Negotiable, based on experience

Refreshed

September 29th, 2026 10:31

General Requirements

Minimum Experience Level

Over 6 years

Career Level

Mid Career

Minimum English Level

Business Level

Minimum Japanese Level

None

Minimum Education Level

Associate Degree/Diploma

Visa Status

No permission to work in Japan required

Job Description

Our client is a well-established multinational company providing advanced electronic materials and solutions to customer across the electronics manufacturing industry.

As part of their business expansion, they are currently looking for an experienced **Senior Field Application (CCL/ PCB)** to provide technical support to PCB customers and support the introduction of new materials and applications.

This position suitable for candidates with experience in PCB manufacturing, CCL materials, PCB process engineering, NPI, lamination, R&D or technical application support who are interested in moving into a regional customer facing technical role.

What we offer:

- Permanent position with an established multinational organization
- Regional exposure covering Malaysia, Singapore and ASEAN

- Opportunity to work closely with customers on advanced PCB and electronic material applications
- Technical and corporate training provided
- Career development opportunities
- Hybrid working arrangement subject to business and department requirement

Job Responsibilities:

- Provide technical support to PCB customers on CCL (Copper Clad Laminate) materials, applications and product related issues
- Recommend suitable materials based on customers PCB processes and technical requirements
- Support the introduction and qualification of new CCL materials at customer sites
- Coordinate customer testing, evaluation, qualification and certification activities
- Support NPI and new customer projects from the technical side
- Investigate PCB defects and process issues, identify root cause and recommend practical solutions
- Work closely with customers R&D, Process, Quality and Engineering teams to resolve technical issues
- Coordinate internally with R&D, Quality, Manufacturing and Sales teams
- Follow up on technical issues and ensure proper solutions are provided to customers
- Keep updated on PCB, HDI and CCL technology development and market trends
- Identify potential applications and technical opportunities that can support business growth
- Provide technical support to customers across Malaysia, Singapore and other ASEAN markets
- Travel overseas when required, including occasional business trips to China

Job Requirements:

- Bachelor Degree in Engineering, Material Science, Chemical Engineering, Electrical/ Electronic Engineering, Science or a related field.
- Candidate should preferably have either:
 - 5 years or more experience in PCB R&D, Process Engineering, Lamination or NPI within a PCB manufacturing environment or
 - 4 years or more experience in Technical Support, Field Application Engineering or Application Engineering within the CCL industry
- Good understanding of the PCB manufacturing process, including HDI processes
- Knowledge of CCL materials and their applications will be strong advantage
- Able to perform PCB defect analysis, troubleshooting and root cause investigation
- Able to independently understand technical problems and recommend practical solutions
- Experience in customer qualification, material certification or NPI will be an advantage
- Good communication and coordination skills, as this position involves regular interaction with customers and internal technical teams
- Strong analytical and problem solving skills
- Able to communicate effectively in Mandarin and English to support relevant customers and regional stakeholders
- Willing to travel within Malaysia and overseas

#LI-JACMY
#Countrymalaysia

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Company Description